

**AMENDMENTS TO THE CLAIMS**

**This listing of claims will replace all prior versions and listings of claims in the application:**

**LISTING OF CLAIMS:**

1. (currently amended): A modular heat-radiation structure comprising:
  - a printed circuit board;
  - a module which generates~~for generating~~ heat, including a first main unit having a fixing hole and a lead for connecting to the printed circuit board;
  - a heat-radiation fin, fixed to the top face of the first main unit, for radiating heat generated in the module;
  - a resin-made ~~and~~ insulating heat shield inserted between the printed circuit board and the first main unit; and
  - a fixing element which~~for fixes~~fixing the heat shield, the module, and the heat-radiation fin; wherein:
    - a lead hole for allowing the lead to pass therethrough and a first fixing hole for allowing the fixing element to pass therethrough are provided in the heat shield, and
    - a second fixing hole for allowing the fixing element to pass therethrough is provided in the printed circuit board.

2. (original): A controller including the modular heat-radiation structure as recited in claim 1, comprising:

a chip fixed onto the printed circuit board and mounted under the first main unit, wherein:  
either a slit or a concave for inserting the chip is formed in the heat shield.

3. (original): A controller including the modular heat-radiation structure as recited in claim 1, comprising:

an electric power source as a source for driving the module; and  
a case, having a mouth for opening the top face of the module, for mounting the printed circuit board, the module, the electric power source, and the heat shield; wherein:  
the case includes a separator for separating from the electric power source the heat-radiation fin and the module.

4. (original): A controller as recited in claim 3, wherein the separator includes:  
a first separator attached to the case so as to be arranged along a side face of the heat-radiation fin, and  
a second separator, being approximately U-shaped, attached to the heat shield so as to be arranged contacting or closed to the first separator.

5. (original): A controller as recited in claim 4, wherein:  
  
the case is made of resin,  
  
the mouth of the case is formed slightly larger than the first main unit, and  
  
a head is provided closed to and facing the bottom face of the heat-radiation fin around  
the mouth of the case.

6. (currently amended): A controller including the modular heat-radiation structure as  
recited in claim 1, comprising:

a stack ~~which for~~ generates generating heat, including a second main unit, whose lead is  
fixed to the printed circuit board, being rectangularly and vertically arranged;

a heat-radiation fin including a mouth for protruding the second main unit of the stack,  
and also including a fold; and

a clip ~~which contacts for contacting~~ the fold to the second main unit, having elasticity  
towards its open/close movement.

7. (previously presented): A controller including the modular heat-radiation structure as  
recited in claim 6, wherein the heat shield is provided with a mouth for allowing the second main  
unit of the stack to pass therethrough, and also with a protrusion for supporting the second main  
unit along the longitudinal orientation of the mouth.